

L Number	Hits	Search Text	DB	Time stamp
1	79	(156/345.13).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/11/16 16:21
2	48	((156/345.13).CCLS.) and conduct\$3	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/11/16 16:22
3	22	((156/345.13).CCLS.) and laser	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/11/16 16:22
-	2176	electrochemical adj deposition	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/11/10 17:50
-	12	((electrochemical adj2 deposition) and detect\$3).clm.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/11/12 18:33
-	313	(electrochemical adj2 deposition).clm.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/11/10 18:18
-	18	(planarity and detection).ab.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/11/10 17:57
-	10273	(deposit\$3 and detect\$3).clm.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/11/10 18:00
-	201	(deposit\$3 and detect\$3 and planar\$5 and light).clm.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/11/10 18:12
-	35	(deposit\$3 and detect\$3 and planar\$5 and light).ab.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/11/10 18:02
-	233	((deposit\$3 and detect\$3 and planar\$5 and light).clm.) or ((deposit\$3 and detect\$3 and planar\$5 and light).ab.)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/11/10 18:01
-	313	(deposit\$3 and detect\$3 and conduct\$3 and light).ab.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/11/10 18:03
-	489	(deposit\$3 and detect\$3 and conduct\$3 and light).clm.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/11/10 18:03
-	787	((deposit\$3 and detect\$3 and conduct\$3 and light).ab.) or ((deposit\$3 and detect\$3 and conduct\$3 and light).clm.)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/11/10 18:03

-	87	(deposit\$3 and sensor and planar\$5 and light).clm.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/11/10 18:29
-	431	(deposit\$3 and reflect\$3 and planar\$5 and light).clm.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/11/10 18:06
-	61	(electrochemical and deposition and detect\$3).clm.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/11/14 19:35
-	7	(electrochemical and metalliz\$5 and detect\$3).clm.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/11/10 18:09
-	453	(metalliz\$5 and detect\$3).clm.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/11/10 18:09
-	126	(metalliz\$5 and detect\$3 and light).clm.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/11/10 18:10
-	9	(metalliz\$5 and detect\$3 and planariz\$5).clm.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/11/10 18:10
-	628	(deposit\$3 and detect\$3 and planar\$5).clm.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/11/10 18:13
-	105	(205/81).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/11/10 18:18
-	129	(205/82).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/11/10 18:26
-	46	(205/87).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/11/10 18:19
-	74	(205/91).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/11/10 18:19
-	23	(205/92).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/11/10 18:19
-	1105	(216/13).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/11/10 18:20

-	1204	(216/18).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/11/10 18:21
-	220	(216/37).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/11/10 18:21
-	357	(216/38).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/11/10 18:22
-	381	(216/88).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/11/10 18:22
-	24	((205/82).CCLS.) and light	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/11/12 14:04
-	3	((205/82).CCLS.) and reflectivity	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/11/10 18:28
-	16	((205/82).CCLS.) and reflect\$3	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/11/10 18:28
-	24	(electroplat\$3 and light and detect\$3).clm.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/11/10 18:29
-	38	(electroplat\$3 and planar\$5 and light).clm.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/11/10 18:30
-	334	(438/697).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/11/12 14:01
-	1658	(438/692).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/11/12 13:59
-	20	((438/697).CCLS.) and detect\$3 and light	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/11/12 14:02
-	1981	(chemical\$1mechanical or (chemical adj mechanical)) and electroplat\$3 and planar\$7	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/11/12 14:10
-	646	(chemical\$1mechanical or (chemical adj mechanical)) and electroplat\$3 and planar\$7 and light	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/11/12 14:10

-	9	((205/82).CCLS.) and beam	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/11/12 16:50
-	52	(electrodeposit\$3 and detect\$3).clm.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/11/12 18:34
-	3	(electrodeposit\$3 and detect\$3 and planar\$7).clm.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/11/12 18:35
-	17	(electrodeposit\$3 and detect\$3 and (light or laser or radiat\$3)).clm.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/11/12 18:37
-	31	((chemical adj mechanical) and detect\$3 and (light or laser or radiat\$3) and (end-point or (end adj point))).clm.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/11/12 18:38
-	2	("4944836").PN.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/11/12 18:41
-	345	electrochemical adj mechanical	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/11/14 19:53
-	10	(electrochemical adj mechanical) and ((end adj point) or end-point)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/11/15 19:02
-	129	(electrochemical adj mechanical) and (detect\$3 or optical or end\$1point or light or inspect\$3)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/11/14 19:49
-	114	(electrochemical adj mechanical) and (planar\$7)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/11/15 14:50
-	30	(electrochemical adj mechanical) and (planar\$7) and (light or laser)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/11/14 19:54
-	56	electrochemical adj mechanical adj deposit\$3	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/11/15 15:03
-	7	(electrochemical adj mechanical adj deposit\$3) and (light or laser)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/11/15 14:37
-	7	(electrochemical adj mechanical adj deposit\$3) and (light or laser or optical)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/11/15 14:38

-	2	("6176992").PN.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/11/15 14:51
-	8	electro-chemical adj mechanical adj deposit\$3	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/11/15 14:51
-	63	electro\$1chemical adj mechanical adj deposit\$3	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/11/15 15:04
-	3	electro\$1chemical\$1mechanical adj deposit\$3	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/11/15 15:04
-	19	electro\$1chemical adj mechanical adj (deposit\$3 and etch\$3)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/11/15 15:04
-	158	(mechanical adj (planariz\$5 or polish\$3)) and ((end adj point) or end-point) and (light or laser) and conductor	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/11/16 13:02
-	427	((copper or conductor) near3 (CMP or (chemical adj mechanical))).ab.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/11/16 13:04
-	11	((copper or conductor) and (CMP or (chemical adj mechanical)) and (end-point or endpoint)).ab.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/11/16 13:05
-	30	((copper or conductor) and (CMP or (chemical adj mechanical)) and (end-point or endpoint)).clm.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/11/16 13:07
-	21	(copper adj CMP).ti.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/11/16 13:08
-	20	(copper and CMP and (light or laser)).clm.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/11/16 13:10
-	310	copper and CMP and (light or laser) and detect\$3 and (end\$1point or endpoint)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/11/16 13:52
-	147	CMP same (light or laser) same detect\$3 same (end\$1point or endpoint)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/11/16 13:14
-	4	(conduct\$3 and CMP and (laser) and detect\$3).ab.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/11/16 13:53

-	23	(conduct\$3 and planar\$7 and (laser) and detect\$3).ab.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/11/16 13:54
-	603	(planar\$7 and (laser) and detect\$3).ab.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/11/16 14:03
-	4	(("5413941") or ("4939370")).PN.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/11/16 14:14
-	11	3737489.URPN.	USPAT	2003/11/16 14:04
-	4	("5131752" "5209813" "5240552" "5271796").PN.	USPAT	2003/11/16 14:04
-	131	5413941.URPN.	USPAT	2003/11/16 14:06
-	0	6576553.URPN.	USPAT	2003/11/16 14:12
-	25	("5069002" "5225034" "5234540" "5240522" "5242524" "5275974" "5314843" "5376483" "5407526" "5413941" "5439553" "5576126" "5637185" "5685951" "5688364" "5763306" "5767018" "5783495" "6037213" "6103456" "6107191" "6114235" "6200875" "6249019" "6458689" "2001/0014498").PN.	USPAT	2003/11/16 14:12
-	100	(endpoint or end\$1point).ti. and laser and ((chemical adj mechanical) or chemical-mechanical)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/11/16 14:15